

# RoHS EARTH FRIENDLY

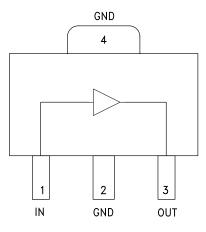
v05.0710

## **Typical Applications**

The HMC454ST89 / HMC454ST89E is ideal for applications requiring a high dynamic range amplifier:

- GSM, GPRS & EDGE
- CDMA & W-CDMA
- CATV/Cable Modem
- Fixed Wireless & WLL

## **Functional Diagram**



# HMC454ST89 / 454ST89E

## InGaP HBT ½ WATT HIGH IP3 AMPLIFIER, 0.4 - 2.5 GHz

## Features

Output IP3: +40 to +42 dBm Gain: 12.5 dB @ 2150 MHz 50% PAE @ +28 dBm Pout +17.5 dBm W-CDMA Channel Power@ -45 dBc ACP Single +5V Supply Industry Standard SOT89 Package Included in the HMC-DK002 Designer's Kit

## **General Description**

The HMC454ST89 & HMC454ST89E are high dynamic range GaAs InGaP Heterojunction Bipolar Transistor (HBT) ½ watt MMIC amplifiers operating between 0.4 and 2.5 GHz. Packaged in a low cost industry standard SOT89, the amplifier gain is typically 17.8 dB from 0.8 to 1.0 GHz and 12.5 dB from 1.8 to 2.2 GHz. Utilizing a minimum number of external components and a single +5V supply, the amplifier output IP3 can be optimized to +40 dBm at 0.9 GHz or +42 dBm at 2.0 GHz. The high output IP3 and PAE makes the HMC454ST89 an ideal driver amplifier for Cellular/PCS/3G, WLL, ISM and Fixed Wireless applications.

## Electrical Specifications, $T_{a} = +25^{\circ}C$ , $Vs = +5V^{[1]}$

Parameter	Min.	Тур.	Max.	Min.	Тур.	Max.	Min.	Тур.	Max.	Units
Frequency Range		824 - 960	)		1800 - 2000	)	:	2000 - 220	0	MHz
Gain	16	17.8		11	12.5		11	12.5		dB
Gain Variation Over Temperature		0.008	0.016		0.008	0.016		0.008	0.016	dB / °C
Input Return Loss		9			7			12		dB
Output Return Loss		13			21			19		dB
Output Power for 1dB Compression (P1dB)	22	24.5		24	27		24	27.5		dBm
Saturated Output Power (Psat)		25.5			28.5			28.5		dBm
Output Third Order Intercept (IP3) [2]	37	40		38	41		38	42		dBm
Noise Figure		8			6.5			5.2		dB
Supply Current (Icq)		150	175		150	175		150	175	mA

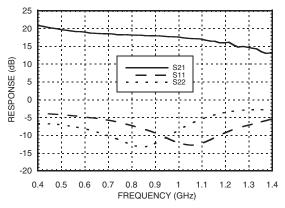
[1] Specifications and data reflect HMC454ST89 measured using the respective application circuits for each designated frequency band found herein. Contact the HMC Applications Group for assistance in optimizing performance for your application. [2] Two-tone input power of 0 dBm per tone, 1 MHz spacing.

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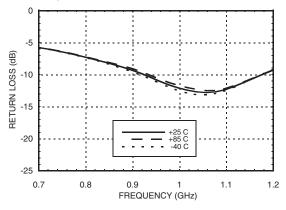




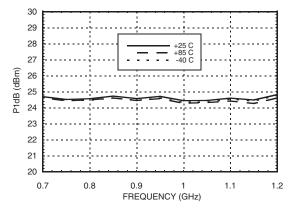
Broadband Gain & Return Loss @ 900 MHz



#### Input Return Loss vs. Temperature @ 900 MHz



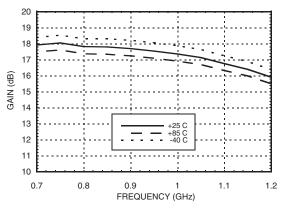
#### P1dB vs. Temperature @ 900 MHz



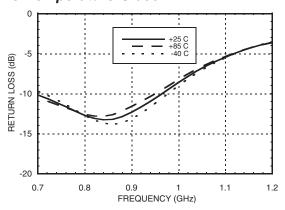
# HMC454ST89 / 454ST89E

## InGaP HBT ½ WATT HIGH IP3 AMPLIFIER, 0.4 - 2.5 GHz

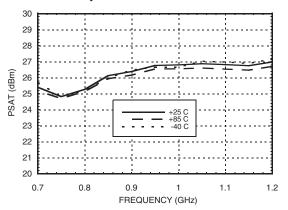
#### Gain vs. Temperature @ 900 MHz



#### Output Return Loss vs. Temperature @ 900 MHz



#### Psat vs. Temperature @ 900 MHz

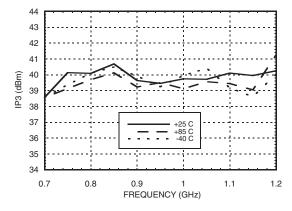


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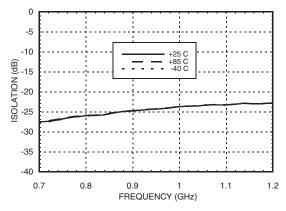




#### Output IP3 vs. Temperature @ 900 MHz

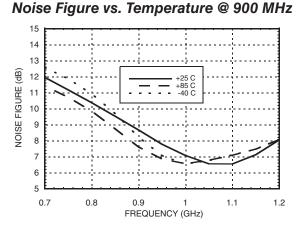


# Reverse Isolation vs. Temperature @ 900 MHz

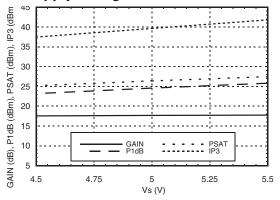


# HMC454ST89 / 454ST89E

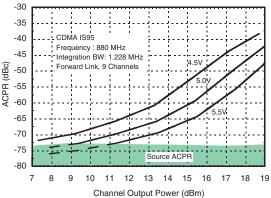
## InGaP HBT ½ WATT HIGH IP3 AMPLIFIER, 0.4 - 2.5 GHz



#### Gain, Power & Output IP3 vs. Supply Voltage @ 900 MHz





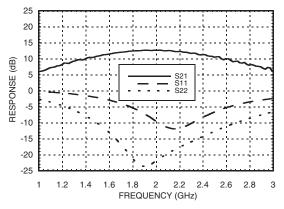


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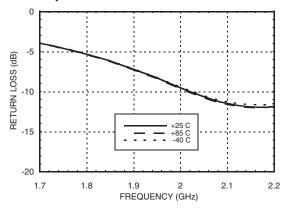




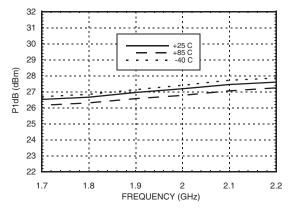
#### Broadband Gain & Return Loss @ 1960 MHz



#### Input Return Loss vs. Temperature @ 1960 MHz

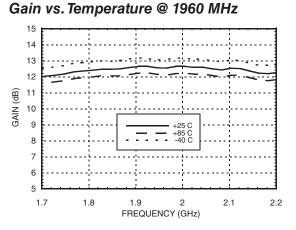


#### P1dB vs. Temperature @ 1960 MHz

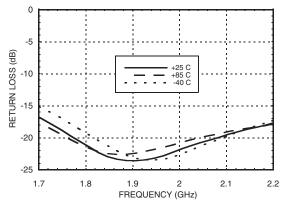


# HMC454ST89 / 454ST89E

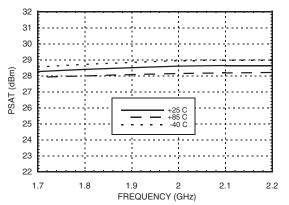
## InGaP HBT ½ WATT HIGH IP3 AMPLIFIER, 0.4 - 2.5 GHz



#### Output Return Loss vs. Temperature @ 1960 MHz



## Psat vs. Temperature @ 1960 MHz

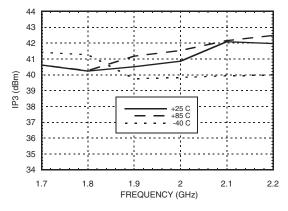


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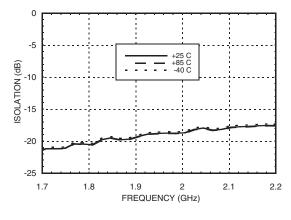




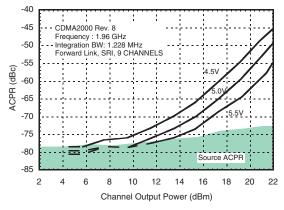
## Output IP3 vs. Temperature @ 1960 MHz



# Reverse Isolation vs. Temperature @ 1960 MHz

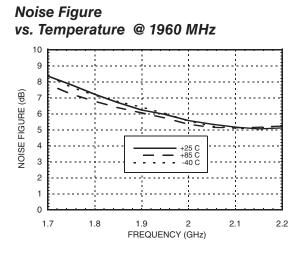


#### ACPR vs. Supply Voltage @ 1.96 GHz CDMA 2000, 9 Channels Forward

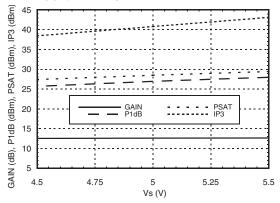


# HMC454ST89 / 454ST89E

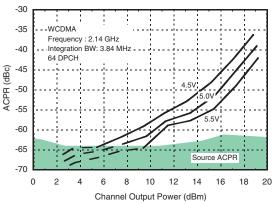
## InGaP HBT ½ WATT HIGH IP3 AMPLIFIER, 0.4 - 2.5 GHz



#### Gain, Power & Output IP3 vs. Supply Voltage @ 1960 MHz







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## Absolute Maximum Ratings

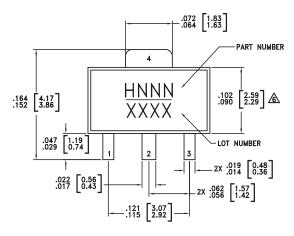
Collector Bias Voltage (Vcc)	+6.0 Vdc
RF Input Power (RFIN)(Vs = +5Vdc)	+25 dBm
Junction Temperature	150 °C
Continuous Pdiss (T = 85 °C) (derate 13.6 mW/°C above 85 °C)	0.890 W
Thermal Resistance (junction to ground paddle)	73 °C/W
Storage Temperature	-65 to +150 °C
Operating Temperature	-40 to +85 °C

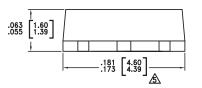
# HMC454ST89 / 454ST89E

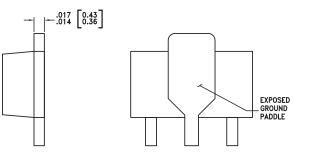
## InGaP HBT ½ WATT HIGH IP3 AMPLIFIER, 0.4 - 2.5 GHz



## **Outline Drawing**







NOTES:

1. LEADFRAME MATERIAL: COPPER ALLOY

2. DIMENSIONS ARE IN INCHES [MILLIMETERS].

A DIMENSION DOES NOT INCLUDE MOLDFLASH OF 0.15mm PER SIDE.

A DIMENSION DOES NOT INCLUDE MOLDFLASH OF 0.25mm PER SIDE.

5. ALL GROUND LEADS MUST BE SOLDERED TO PCB RF GROUND.

## **Package Information**

Part Number	Package Body Material	Lead Finish	MSL Rating	Package Marking <sup>[3]</sup>
HMC454ST89	Low Stress Injection Molded Plastic	Sn/Pb Solder	MSL1 [1]	H454 XXXX
HMC454ST89E	RoHS-compliant Low Stress Injection Molded Plastic	100% matte Sn	MSL1 <sup>[2]</sup>	H454 XXXX

[1] Max peak reflow temperature of 235  $^\circ\text{C}$ 

[2] Max peak reflow temperature of 260 °C

[3] 4-Digit lot number XXXX

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# HMC454ST89 / 454ST89E

## InGaP HBT ½ WATT HIGH IP3 AMPLIFIER, 0.4 - 2.5 GHz

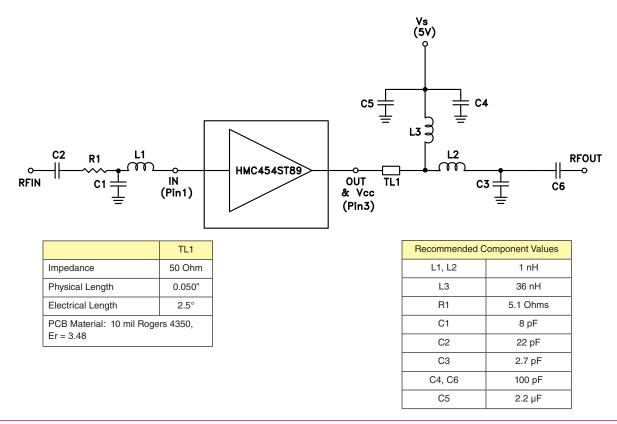


## **Pin Descriptions**

Pin Number	Function	Description	Interface Schematic
1	RFIN	This pin is AC coupled. Off chip matching components are required. See Application Circuit herein.	
3	RFOUT	RF output and DC Bias input for the output amplifier stage. Off chip matching components are required. See Application Circuit herein.	
2,4	GND	These pins & package bottom must be connected to RF/DC ground.	⊖ GND 

## 900 MHz Application Circuit, Compact Layout

This circuit was used to specify the performance for 894-960 MHz operation. This circuit will satisfy many applications from 700 to 1200 MHz. Contact the HMC Applications Group for assistance in optimizing performance for your application.



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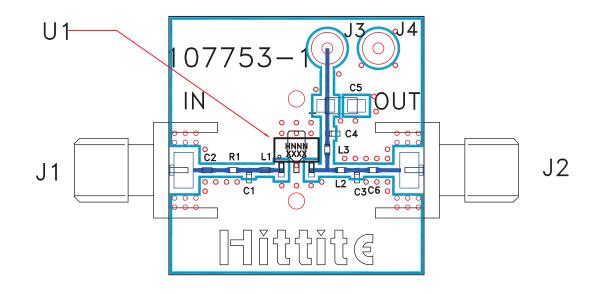


# HMC454ST89 / 454ST89E

## InGaP HBT ½ WATT HIGH IP3 AMPLIFIER, 0.4 - 2.5 GHz



## 900 MHz Evaluation PCB



## List of Materials for Evaluation PCB 107755 [1]

Item	Description
J1 - J2	PCB Mount SMA Connector
J3 -J4	DC Pins
C1	8 pF Capacitor, 0402 Pkg.
C2	22 pF Capacitor, 0402 Pkg.
C3	2.7 pF Capacitor, 0402 Pkg.
C4, C6	100 pF Capacitor, 0402 Pkg.
C5	2.2 µF Capacitor, Tantalum
L1, L2	1 nH Inductor, 0402 Pkg.
L3	36 nH Inductor, 0402 Pkg.
R1	5.1 Ohms
U1	HMC454ST89 / HMC454ST89E Linear Amp
PCB [2]	107753 Evaluation PCB, 10 mils

[1] Reference this number when ordering complete evaluation PCB

[2] Circuit Board Material: Rogers 4350, Er = 3.48

The circuit board used in this application should use RF circuit design techniques. Signal lines should have 50 Ohm impedance while the package ground leads and exposed paddle should be connected directly to the ground plane similar to that shown. A sufficient number of via holes should be used to connect the top and bottom ground planes. The evaluation board should be mounted to an appropriate heat sink. The evaluation circuit board shown is available from Hittite upon request. 9

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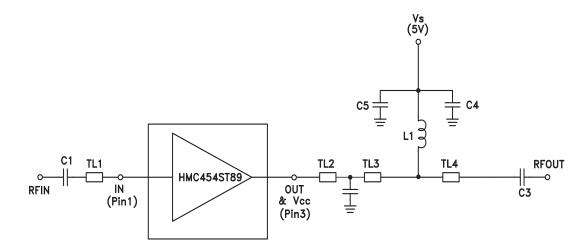
# HMC454ST89 / 454ST89E

## InGaP HBT ½ WATT HIGH IP3 AMPLIFIER, 0.4 - 2.5 GHz



## 1960 & 2140 MHz Application Circuit

This circuit was used to specify the performance for 1800-2000 and 2000-2200 MHz operation. This circuit will satisfy many applications from 1700 to 2500 MHz. Contact the HMC Applications Group for assistance in optimizing performance for your application.



	TL1	TL2	Т3	TL4
Impedance	50 Ohm	50 Ohm	50 Ohm	50 Ohm
Physical Length	0.32"	0.10"	0.07"	0.17"
Electrical Length	34°	11°	8°	18.5°
PCB Material: 10 mil Rogers 4350, Er = 3.48				

Recommended Component Values		
L1	8.2 nH	
C1	1 pF	
C2	1.2 pF	
C3	3 pF	
C4	100 pF	
C5	2.2 μF	

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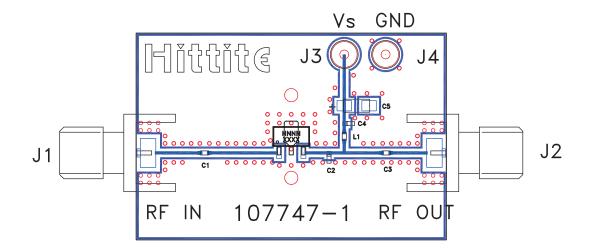
# HMC454ST89 / 454ST89E

## InGaP HBT ½ WATT HIGH IP3 AMPLIFIER, 0.4 - 2.5 GHz



## 1960 & 2140 MHz Evaluation PCB

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## List of Materials for Evaluation PCB 107749 [1]

Item	Description
J1 - J2	PCB Mount SMA Connector
J3 - J4	DC Pins
C1	1.0 pF Capacitor, 0402 Pkg.
C2	1.2 pF Capacitor, 0402 Pkg.
C3	3.0 pF Capacitor, 0402 Pkg.
C4	100 pF Capacitor, 0402 Pkg.
C5	2.2 µF Capacitor, Tantalum
L1	8.2 nH Inductor, 0402 Pkg.
U1	HMC454ST89 / HMC454ST89E
PCB [2]	107747 Evaluation PCB, 10 mils

[1] Reference this number when ordering complete evaluation PCB

[2] Circuit Board Material: Rogers 4350, Er = 3.48

The circuit board used in this application should use RF circuit design techniques. Signal lines should have 50 Ohm impedance while the package ground leads and exposed paddle should be connected directly to the ground plane similar to that shown. A sufficient number of via holes should be used to connect the top and bottom ground planes. The evaluation board should be mounted to an appropriate heat sink. The evaluation circuit board shown is available from Hittite upon request. AMPLIFIERS - LINEAR & POWER - SMT

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# HMC454ST89 / 454ST89E

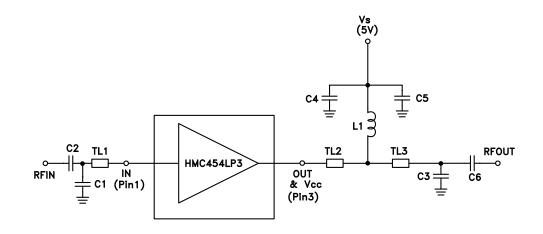
## InGaP HBT ½ WATT HIGH IP3 AMPLIFIER, 0.4 - 2.5 GHz



## Alternative 900 MHz Application Circuit, Optimal OIP3 Layout

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This alternate application circuit for 900 MHz applications features a resonating I/O structure on the PCB that, while using more PCB area, will improve output IP3 from +40 dBm to +42 dBm. This circuit will satisfy many applications from 700 to 1200 MHz as the typical performance below demonstrates. Contact the HMC Applications Group for assistance in optimizing performance for your application.



	TL1	TL2	TL3
Impedance	50 Ohm	50 Ohm	50 Ohm
Physical Length	0.35"	0.05"	0.53"
Electrical Length	18°	2.5°	27°
PCB Material: 10 mil Rogers 4350, Er = 3.48			

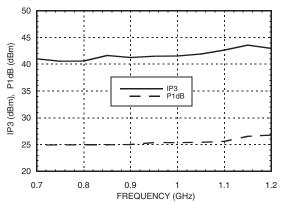
Recommended Component Values		
L1	18 nH	
C1	4 pF	
C2, C6	10 pF	
C3	3 pF	
C4	100 pF	
C5	2.2 µF	

# Broadband Gain & Return Loss

0.5 0.6 0.7 0.8 0.9

0.4

#### Output IP3 & P1dB



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1 1.1

FREQUENCY (GHz)

1.2 1.3

1.4

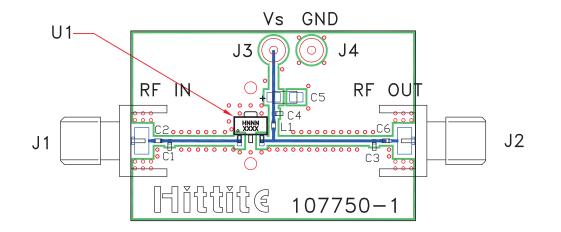


# HMC454ST89 / 454ST89E

## InGaP HBT ½ WATT HIGH IP3 AMPLIFIER, 0.4 - 2.5 GHz



## Alternate 900 MHz Evaluation PCB



## List of Materials

Item	Description	
J1 - J2	PCB Mount SMA Connector	
J3 - J4	DC Pins	
C1	4 pF Capacitor, 0402 Pkg.	
C2, C6	10 pF Capacitor, 0402 Pkg.	
C3	3.0 pF Capacitor, 0402 Pkg.	
C4	100 pF Capacitor, 0402 Pkg	
L1	18 nH Inductor, 0402 Pkg.	
U1	HMC454ST89 / HMC454ST89E	
PCB*	107750 Evaluation PCB, 10 mils	
* Circuit Board Material: Rogers 4350, Er = 3.48		

The circuit board used in this application should use RF circuit design techniques. Signal lines should have 50 Ohm impedance while the package ground leads and exposed paddle should be connected directly to the ground plane similar to that shown. A sufficient number of via holes should be used to connect the top and bottom ground planes. The evaluation board should be mounted to an appropriate heat sink. The evaluation circuit board shown is available from Hittite upon request.

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